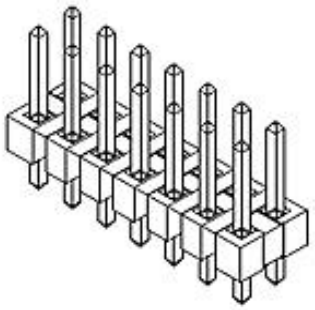
Part Number : 879142016
Product Description : 2.54mm Pitch C-Grid Header, Through Hole, Dual Row, Vertical, 20 Circuits, 2.50µm Tin (Sn) Overall Plating, Tray Packaging, Lead-Free
Series Number : 87914
Status : Active
Product Category : PCB Headers and Receptacles



Documents & Resources

Drawings

879142016_sd.pdf

PK-89990-489-001.pdf

3D Models and Design Files

STEP AP242

SOLIDWORKS

Creo

Symbol and Footprint (Multi-Format)

Specifications

713080001-AS-000.pdf

PS-87920-019-001.pdf

879200001-TS-000.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Compliant with Exemption 44; 34; 33
China RoHS	per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)4165-DC (25 June 2025)
EU RoHS	Compliant per EU 2015/863

Compliance Statements

- EU RoHS
- REACH SVHC
- Low-Halogen

Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest

- PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Active
Category	PCB Headers and Receptacles
Series	87914
Description	2.54mm Pitch C-Grid Header, Through Hole, Dual Row, Vertical, 20 Circuits, 2.50µm Tin (Sn) Overall Plating, Tray Packaging, Lead-Free
Application	Board-to-Board, Signal, Wire-to-Board
Component Type	PCB Header
Product Name	C-Grid
UPC	822348867783

Agency

UL	E29179

Electrical

Current - Maximum per Contact	3.0A
Voltage - Maximum	250V

Physical

Breakaway	Yes
Circuits (Loaded)	20
Circuits (maximum)	20
Color - Resin	Black
First Mate / Last Break	No
Flammability	94V-0
Glow-Wire Capable	No
Guide to Mating Part	No
Keying to Mating Part	None
Lock to Mating Part	None
Mated Height	5.84mm
Material - Metal	Copper Alloy
Material - Plating Mating	Tin
Material - Plating Termination	Nickel
Material - Resin	High Temperature Thermoplastic
Net Weight	1.120/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Tray
PCB Locator	No
PCB Retention	None
PCB Thickness - Recommended	1.60mm
PC Tail Length	2.79mm
Pitch - Mating Interface	2.54mm
Pitch - Termination Interface	2.54mm
Plating min - Mating	2.540µm
Plating min - Termination	1.270µm
Polarized to Mating Part	No
Polarized to PCB	No
Shrouded	No
Stackable	No
Temperature Range - Operating	-55° to +105°C
Termination Interface Style	Through Hole

Solder Process Data

Max-Duration	12
Lead-Free Process Capability	WAVE
Max-Cycle	1
Max-Temp	260

Mates With / Use With

Mates with Part(s)

Description	Part Number
SL Dual Row Crimp Housings	70450
C-Grid Vertical, Dual Row, High Profile, Through Hole PCB Receptacles	71850
2.54mm Pitch C-Grid Shunt Terminal Housings	7859